

MCR72-3, MCR72-6, MCR72-8





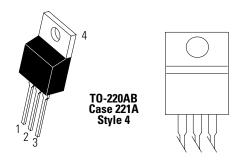
Description

Designed for industrial and consumer applications such as temperature, light and speed control; process and remote controls; warning systems; capacitive discharge circuits and MPU interface.

Features

- Center Gate Geometry for Uniform Current Density
- All Diffused and Glass-Passivated Junctions for Parameter Uniformity and Stability
- Small, Rugged Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Low Trigger Currents, 200
 A Maximum for Direct
 Driving from Integrated
 Circuits
- These are Pb-Free Devices

Pin Out



Functional Diagram



Additional Information









Maximum Ratings (T _J = 25°C unless otherwise noted)					
Rating		Symbol	l Value	Unit	
Peak Repetitive Off-State Voltage (Note 1) (- 40 to 110°C, Sine Wave, 50 to 60 Hz, Gate Open)	MCR72-3 MCR72-6 MCR72-8	V _{DRM} , V _{RRM}	100 400 600	V	
On-State RMS Current (180° Conduction Angles; $T_c = 83$ °C)		I _{TM (RMS)}	8.0	А	
Peak Non-Repetitive Surge Current (1/2 Cycle, Sine Wave 60 Hz, $T_J = 110^{\circ}$ C		I _{TSM}	100	А	
Average On-State Current (180° Conduction Angles; $T_c = 83$ °C)		I _{T(AV)}	8.0	А	
Circuit Fusing Consideration (t = 8.3 ms)		l²t	40	A²s	
Forward Peak Gate Voltage (Pulse Width ≤ 10 µsec, T _C = 83°C)		V_{gM}	±5.0	V	
Forward Peak Gate Current (Pulse Width ≤ 10 µsec, T _C = 83°C)		I _{GM}	2.0	А	
Forward Peak Gate Power (Pulse Width ≤ 10 µsec, T _c = 83°C)		I _{GM}	20	W	
Average Gate Power (t = 8.3 ms, T_c = 83°C)		P _{G(AV)}	0.75	W	
Operating Junction Temperature Range		T _J	-40 to +110	°C	
Storage Temperature Range		T _{stg}	-40 to +150	°C	
Mounting Torque		_	8.0	in. lb.	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Thermal Characteristics

Characterstic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	R _{euc}	2.2	°C/W
Thermal Resistance, Junction-to-Ambient	R _{eJA}	60	C/VV
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	T _L	260	°C

Electrical Characteristics - OFF (T₁ = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Blocking Current	T _J = 25°C	I _{DRM}	-	-	10	
$(V_{AK} = V_{DRM} = V_{RRM}; Gate Open)$	T _J = 125°C	IRRM	-	-	2.0	μΑ
High Logic Level Supply Current from V _{cc}		I _{cch}	4	4	μΑ	

Electrical Characteristics - ON (T_J = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Peak Forward On–State Voltage ($I_{TM} = 16$ A Peak, Pulse Width ≤ 1 ms, Duty Cycle $\leq 2\%$)	V _{TM}	-	-	2.0	V
Gate Trigger Current (Continuous dc) (Note 3) ($V_D = 12 \text{ V}; R_L = 100 \Omega$)	I _{GT}	_	30	200	μΑ
Gate Trigger Voltage (Continuous dc) (Note 3) ($V_D = 12 \text{ V}; R_L = 100 \Omega$)	V _{GT}	_	0.5	1.5	V
Gate Trigger Non-Trigger Voltage ($V_D = 12 \text{ Vdc}$, $R_L = 100 \Omega$, $T_J = 110^{\circ}\text{C}$)	V _{GD}	0.1	_	_	V
Holding Current ($V_D = 12 \text{ V, Initiating Current} = 200 \text{ mA, RGK} = 1 \text{k}\Omega$)	I _H	_	_	6.0	mA
Gate Controlled Turn-On Time (Note 5) $(V_D = Rated V_{DRM'} I_{TM} = 16 A, I_G = 2 mA)$	t _{gt}	-	1.0	-	μs

^{1.} V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Dynamic Characteristics

Characteristic	Symbol	Min	Тур	Max	Unit
Critical Rate-of-Rise of Off-State Voltage $(V_D = Rated V_{DRM'} Exponential Waveform, Gate Open, T_J = 125°C)$	dv/dt	-	10	_	V/µs
Critical Rate of Rise of On–State Current $I_{\rm G} = 150~{\rm mA}$, $T_{\rm J} = 125^{\circ}{\rm C}$	di/dt	_	_	75	A/µs

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Voltage Current Characteristic of SCR

Symbol	Parameter
V _{DRM}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current

Figure 1. Average Current Derating

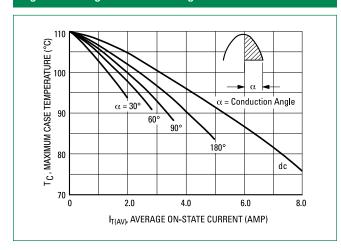
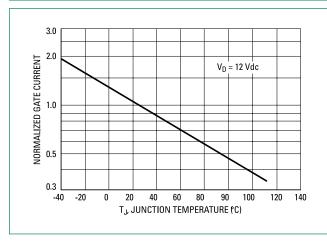


Figure 3. Normalized Gate Current



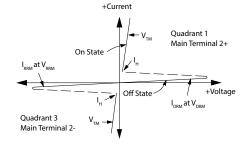


Figure 2. On-State Power Dissipation

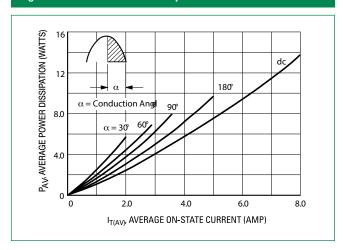
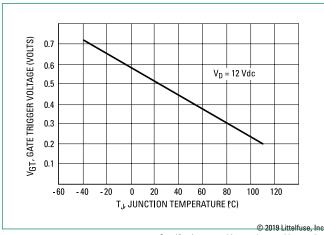


Figure 4. Gate Voltage



^{2.} Ratings apply for negative gate voltage or R_{GK} = 1 Ω. Devices shall not have a positive gate voltage concurrently with a negative voltage on the anode. Devices should not be tested with a constant current source for forward and reverse blocking capability such that the voltage applied exceeds the rated blocking voltage. 3. RGK current not included in measurement.

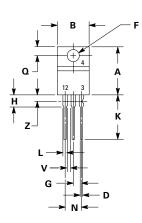
Part Marking System

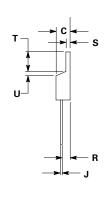


Dimensions

TO-220 Case 221A-01 Issue O

TO-220 Case 221A-09 Issue AH





	1 2 3	4	
	/MAXX CR72-xG AKA	<u></u>	YMAXX ICR72-6TG AKA
MCR72-x Y M A AKA G	=Device Code =Year =Month =Assembly Site =Diode Polarity =Pb-Free Package	MCR72-6T Y M A AKA G	=Device Code =Year =Month =Assembly Site =Diode Polarity =Pb-Free Package

Dim	Inc	Inches		neters
Dim	Min	Max	Min	Max
Α	0.590	0.620	14.99	15.75
В	0.380	0.420	9.65	10.67
С	0.178	0.188	4.52	4.78
D	0.025	0.035	0.64	0.89
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.41	2.67
Н	0.110	0.130	2.79	3.30
J	0.018	0.024	0.46	0.61
К	0.540	0.575	13.72	14.61
L	0.060	0.075	1.52	1.91
N	0.195	0.205	4.95	5.21
Q	0.105	0.115	2.67	2.92
R	0.085	0.095	2.16	2.41
S	0.045	0.060	1.14	1.52
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z	_	0.080		2.04

Pin Assignment			
1	Cathode		
2	Anode		
3	Gate		
4	Anode		

Ordering Information

Device	Package	Shipping
MCR72-3G		
MCR72-6G		
MCR72-6TG	TO-220AB (Pb-Free)	500 Units / Box
MCR72-8G		
MCR72-8TG		

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

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